SiHF15N65E



RoHS

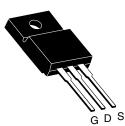
HALOGEN FREE

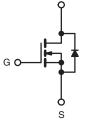


E Series Power MOSFET

PRODUCT SUMMA	RY			
V _{DS} (V) at T _J max.	700			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.28		
Q _g max. (nC)	96			
Q _{gs} (nC)	11			
Q _{gd} (nC)	21			
Configuration	Sing	le		

TO-220 FULLPAK





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of
- compliance please see www.vishay.com/doc?99912 Note
- This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF15N65E-E3
Lead (Pb)-free and Halogen-free	SiHF15N65E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	650	V	
Gate-Source Voltage			V _{GS}	± 30		
Continuous Drain Current (T 150 °C) 8	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D -	15		
Continuous Drain Current (T _J = 150 $^{\circ}$ C) e	VGS AL TO V	T _C = 100 °C		10	A	
Pulsed Drain Current ^a		I _{DM}	38			
Linear Derating Factor				0.27	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	286	mJ	
Maximum Power Dissipation			PD	34	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		-0.77-11	37			
Reverse Diode dV/dt ^d		dV/dt	23	V/ns		
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.5 A.

1.6 mm from case.

d. $I_{SD} \le I_D$, dl/dt = 100 A/µs, starting $T_J = 25$ °C. e. Limited by maximum junction temperature.



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		65			00.00	
Maximum Junction-to-Case (Drain)	R _{thJC}	- 3.7				°C/W		
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static					ļ	ļ	Į	<u>I</u>
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D =	250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C	, I _D = 1 mA	-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V
	00(11)		$V_{GS} = \pm 20$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 V$		-	-	± 1	μA
			= 650 V, V ₀		-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}			V _{GS} = 0 V, T _J = 125 °C		-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		I _D = 8 A	-	0.23	0.28	Ω
Forward Transconductance	g fs	V _{DS}	s = 30 V, I _D	= 8 A	-	5.6	-	S
Dynamic						I	<u></u>	
Input Capacitance	C _{iss}		V _{GS} = 0 \	/	-	1640	-	
Output Capacitance	Coss		$V_{DS} = 100$	V,	-	80	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MH	z	-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		(1. 500.)/		-	63	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	- V _{DS} = 0 V	7 to 520 V,	$V_{GS} = 0 V$	-	213	-	
Total Gate Charge	Qg				-	48	96	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 8	A, V _{DS} = 520 V	-	11	-	nC
Gate-Drain Charge	Q _{gd}				-	21	-	
Turn-On Delay Time	t _{d(on)}				-	18	36	
Rise Time	t _r	V_{DD} = 520 V, I _D = 8 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	24	48	ns	
Turn-Off Delay Time	t _{d(off)}			-	48	96		
Fall Time	t _f				-	25	50	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.8	-	Ω	
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol		-	-	15	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	38	A
Diode Forward Voltage	V _{SD}	T _{.J} = 25 °	C, I _S = 8 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}	<u> </u>			-	325	-	ns
Reverse Recovery Charge	Q _{rr}		25 °C, I _F =		-	4.6	-	μC
Reverse Recovery Current	I _{RRM}	dl/dt = -	100 A/µs, '	$V_{\rm R} = 400 {\rm V}$	_	20	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

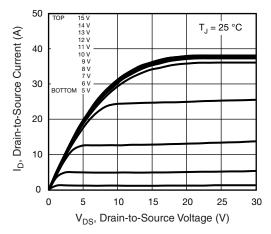


Fig. 1 - Typical Output Characteristics

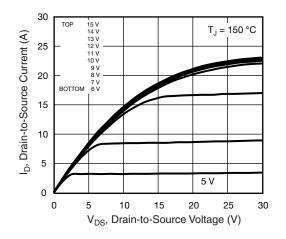


Fig. 2 - Typical Output Characteristics

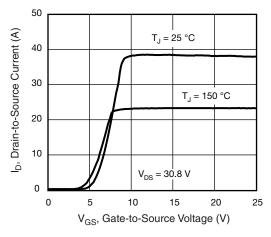


Fig. 3 - Typical Transfer Characteristics

3 8/ R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 = 10 V GS 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

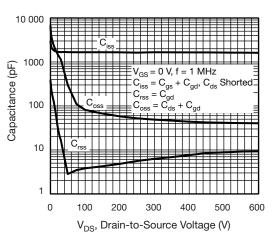


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

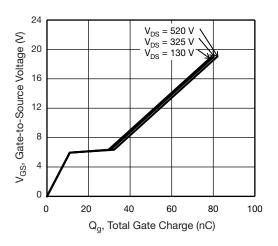


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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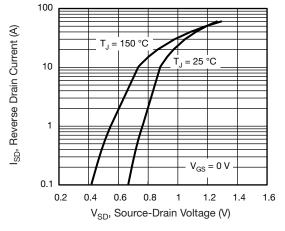
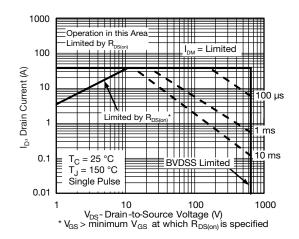


Fig. 7 - Typical Source-Drain Diode Forward Voltage





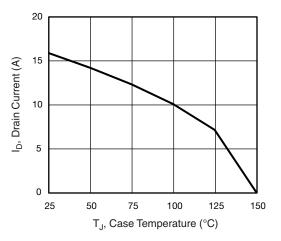


Fig. 9 - Maximum Drain Current vs. Case Temperature

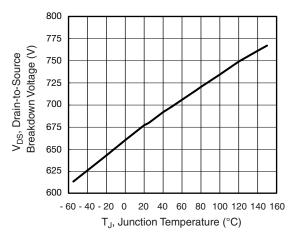
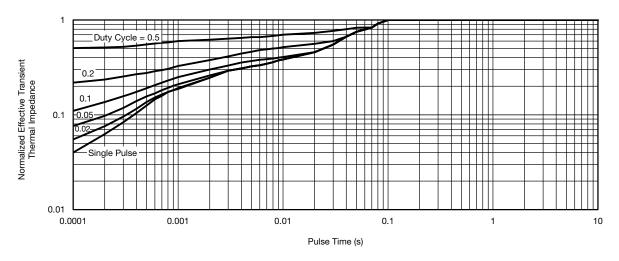


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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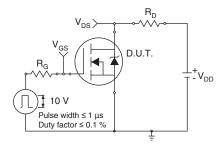


Fig. 12 - Switching Time Test Circuit

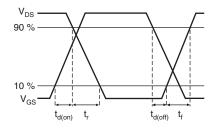


Fig. 13 - Switching Time Waveforms

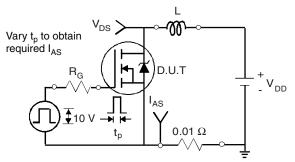


Fig. 14 - Unclamped Inductive Test Circuit

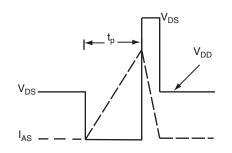


Fig. 15 - Unclamped Inductive Waveforms

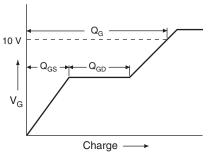


Fig. 16 - Basic Gate Charge Waveform

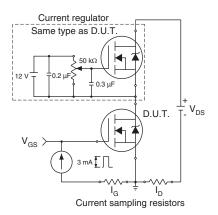


Fig. 17 - Gate Charge Test Circuit

5



Peak Diode Recovery dV/dt Test Circuit

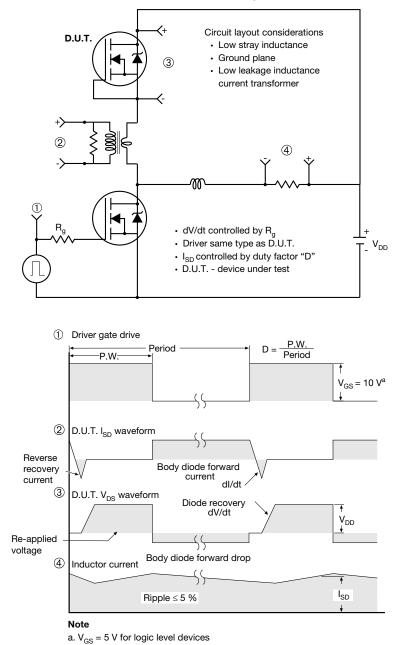


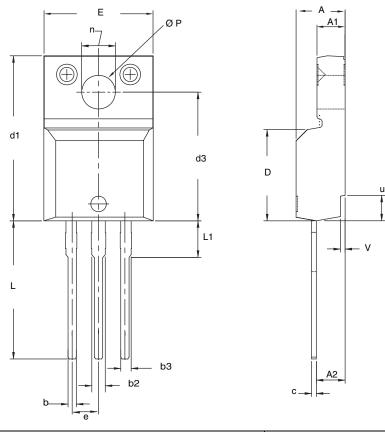
Fig. 18 - For N-Channel

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Package Information

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TO-220 FULLPAK (HIGH VOLTAGE)



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØР	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$.

4. All dimensions include burrs and plating thickness.

5. No chipping or package damage.



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